## Silicon Carbide (SiC) Schottky Diode - EliteSiC, 6 A, 650 V, D2, DPAK <br> FFSD0665B-F085

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

## Features

- Max Junction Temperature $175^{\circ} \mathrm{C}$
- Avalanche Rated 24.5 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery / No Forward Recovery
- AEC-Q101 Qualified and PPAP Capable
- These Devices are $\mathrm{Pb}-$ Free, Halogen Free/BFR Free and are RoHS Compliant


## Applications

- Automotive HEV-EV Onboard Chargers
- Automotive HEV-EV DC-DC Converters

MAXIMUM RATINGS $\left(T_{J}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Parameter |  | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Peak Repetitive Reverse Voltage |  | $\mathrm{V}_{\text {RRM }}$ | 650 | V |
| Single Pulse Avalanche Energy $\left(\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}\right.$, $\left.\mathrm{L}_{\mathrm{L}(\mathrm{pk})}=9.9 \mathrm{~A}, \mathrm{~L}=0.5 \mathrm{mH}, \mathrm{V}=50 \mathrm{~V}\right)$ |  | $\mathrm{E}_{\text {AS }}$ | 24.5 | mJ |
| Continuous Rectified Forward Current | $\mathrm{T}_{\mathrm{C}}<154$ | $\mathrm{I}_{\mathrm{F}}$ | 6.0 | A |
|  | $\mathrm{T}_{\mathrm{C}}<135$ |  | 9.1 |  |
| Non-Repetitive Peak Forward Surge Current | $\begin{aligned} & \mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}, \\ & \mathrm{t}_{\mathrm{P}}=10 \mu \mathrm{~s} \end{aligned}$ | $\mathrm{I}_{\text {FM }}$ | 493 | A |
|  | $\begin{aligned} \mathrm{T}_{\mathrm{C}} & =150^{\circ} \mathrm{C}, \\ \mathrm{t}_{\mathrm{p}} & =10 \mu \mathrm{~s} \end{aligned}$ |  | 442 |  |
| Non-Repetitive Forward Surge Current (Half-Sine Pulse) | $\begin{gathered} \mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C} \\ \mathrm{t}_{\mathrm{P}}=8.3 \mathrm{~ms} \end{gathered}$ | $\mathrm{I}_{\text {FSM }}$ | 28 | A |
| Power Dissipation | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\text {tot }}$ | 75 | W |
|  | $\mathrm{T}_{\mathrm{C}}=150^{\circ} \mathrm{C}$ |  | 12.5 |  |
| Operating Junction and Storage Temperature Range |  | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\text {stg }}$ | $\begin{gathered} -55 \text { to } \\ +175 \end{gathered}$ | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

| $\mathbf{V}_{\mathbf{R R M}}$ | $\mathbf{I}_{\mathbf{F}}$ |
| :---: | :---: |
| 650 V | 6.0 A |



## Schottky Diode



ORDERING INFORMATION
See detailed ordering and shipping information on page 2 of this data sheet.

THERMAL RESISTANCE

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{R}_{\text {өJC }}$ | Thermal Resistance, Junction-to-Case | 2.0 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ON CHARACTERISTICS |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{F}}$ | Forward Voltage | $\mathrm{I}_{\mathrm{F}}=6.0 \mathrm{~A}, \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ | - | 1.38 | 1.7 | V |
|  |  | $\mathrm{I}_{\mathrm{F}}=6.0 \mathrm{~A}, \mathrm{~T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ | - | 1.53 | 2.0 |  |
|  |  | $\mathrm{I}_{\mathrm{F}}=6.0 \mathrm{~A}, \mathrm{~T}_{J}=175^{\circ} \mathrm{C}$ | - | 1.67 | 2.4 |  |
| $\mathrm{I}_{\mathrm{R}}$ | Reverse Current | $\mathrm{V}_{\mathrm{R}}=650 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ | - | 0.5 | 40 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{R}}=650 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ | - | 1.0 | 80 |  |
|  |  | $\mathrm{V}_{\mathrm{R}}=650 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=175^{\circ} \mathrm{C}$ | - | 2.0 | 160 |  |

CHARGES, CAPACITANCES \& GATE RESISTANCE

| $\mathrm{Q}_{\mathrm{C}}$ | Total Capacitive Charge | $\mathrm{V}_{\mathrm{C}}=400 \mathrm{~V}$ | - | 16 | - | nC |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\text {tot }}$ |  | $\mathrm{V}_{\mathrm{R}}=1 \mathrm{~V}, \mathrm{f}=100 \mathrm{kHz}$ | - | 259 | - | pF |
|  |  | $\mathrm{V}_{\mathrm{R}}=200 \mathrm{~V}, \mathrm{f}=100 \mathrm{kHz}$ | - | 29 | - |  |
|  |  | $\mathrm{V}_{\mathrm{R}}=400 \mathrm{~V}, \mathrm{f}=100 \mathrm{kHz}$ | - | 22 | - |  |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PART MARKING AND ORDERING INFORMATION

| Part Number | Top Mark | Package | Packing Method $^{\dagger}$ | Reel Size | Tape Width | Quantity |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| FFSD0665B-F085 | FFSD0665B | DPAK | Tape \& Reel | 330 mm | 16 mm | 2500 units |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## TYPICAL CHARACTERISTICS



Figure 1. Forward Characteristics


Figure 3. Current Derating


Figure 5. Capacitive Charge vs. Reverse Voltage


Figure 2. Reverse Characteristics


Figure 4. Power Derating


Figure 6. Capacitance vs. Reverse Voltage

TYPICAL CHARACTERISTICS


Figure 7. Capacitance Stored Energy


Figure 8. Junction-to-Case Transient Thermal Response


## DPAK3 (TO-252 3 LD)

CASE 369AS
ISSUE A
DATE 28 SEP 2022


IODE PRODUCTS VERSION


GENERIC
MARKING DIAGRAM*

| XXXXXX |
| :---: |
| XXXXXX |
| AYWWZZ |

XXXX = Specific Device Code A = Assembly Location Y = Year
WW = Work Week
ZZ = Assembly Lot Code


DETAIL A
(ROTATED -90\%)
sCALE: 12X


|  | 4.572 BSC |  |  |
| :--- | :---: | :---: | :---: |
| e 1 |  |  |  |
| H | 9.40 | 9.91 | 10.41 |
| L | 1.40 | 1.59 | 1.78 |
| L1 | 2.90 REF |  |  |
| L2 | 0.51 BSC |  |  |
| L3 | 0.89 | 1.08 | 1.27 |
| L4 | --- | --- | 1.02 |
| $\theta$ | $0^{\circ}$ | --- | $10^{\circ}$ |



LAND PATTERN RECOMMENDATION
*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | DPAK3 (TO-252 3 LD) | PAGE 1 OF 1 |

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